

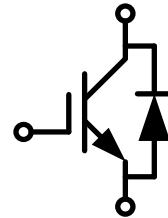


DONGGUAN NANJING ELECTRONICS LTD.,  
TO-247-3 Plastic-Encapsulate IGBT

## NJ75R07A6UB IGBT Discrete with Anti-Parallel Diode

### 电气特性/ Features and Benefits:

- 650V 沟槽栅/场终止工艺  
650V Trench Gate/Field Termination Process
- 低开关损耗  
Low switching losses
- Vcesat 正温度系数  
Vcesat has a positive temperature coefficient



### 典型应用/ Applications:

- 充电桩  
Charging pile
- 不间断电源  
Uninterruptible power supplies
- 光伏逆变器  
Solar converters



V<sub>CES</sub> = 650V, I<sub>C nom</sub> = 75A / I<sub>CRM</sub> = 300A

### 关键性能和程序参数 / Key Performance and Package Parameters

Type	V <sub>CE</sub>	I <sub>C</sub>	V <sub>CESat</sub> , T <sub>vj</sub> =25°C	T <sub>vjmax</sub>	Package
NJ75R07A6UB	650V	75A	1.56V	175°C	TO-247-3L

## 双极晶体管/IGBT

### 最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
集电极-发射极电压 Collector-Emitter voltage	T <sub>vj</sub> =25°C	V <sub>CES</sub>	650	V
连续集电极直流电流 Continuous DC collector current	T <sub>C</sub> =100°C, T <sub>vj max</sub> =175°C	I <sub>C nom</sub>	75	A
集电极重复峰值电流 Repetitive peak collector current	t <sub>p</sub> =1 ms	I <sub>CRM</sub>	300	A
栅极-发射极电压 Gate emitter voltage	t <sub>p</sub> ≤ 10μs, D<0.010	V <sub>GE</sub>	±20 ±30	V
总功率损耗 Power dissipation	T <sub>C</sub> =25°C T <sub>C</sub> =100°C	P <sub>tot</sub>	520 260	W

## Typical Characteristics

在开关状态下温度 Temperature under switching conditions		T <sub>vj op</sub>	-40...+175	°C
储存温度 Storage temperature		T <sub>stg</sub>	-40...+150	°C
焊接温度 Soldering temperature			260	°C
安装扭矩 Mounting torque		M	0.6	Nm

### 热特性 / Thermal Characteristics

Parameter	Conditions	Symbol	Value	Unit
IGBT 热阻, 结-壳 IGBT thermal resistance, junction - case		R <sub>th(j-C)</sub>	0.29	K/W
二极管热阻, 结-壳 Diode thermal resistance, junction - case		R <sub>th(j-C)</sub>	0.27	K/W

### 特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit	
			Min.	Typ.	Max.		
集电极-发射极饱和电压 Collector-Emitter saturation voltage	V <sub>GE</sub> =15V, I <sub>C</sub> =75A	V <sub>CEsat</sub>	T <sub>vj</sub> =25°C T <sub>vj</sub> =150°C T <sub>vj</sub> =175°C	1.56	2.00	V	
	V <sub>GE</sub> =15V, I <sub>C</sub> =75A			1.86			
	V <sub>GE</sub> =15V, I <sub>C</sub> =75A			1.90			
栅极-发射极阈值电压 Gate-Emitter threshold voltage	I <sub>C</sub> =0.75mA, V <sub>GE</sub> = V <sub>CE</sub>	V <sub>GE(th)</sub>	T <sub>vj</sub> =25°C	3.8	4.4	5.0	V
跨导 Transconductance	V <sub>CE</sub> =20V, I <sub>C</sub> =75A	G <sub>fs</sub>		58			S
输入电容 Input capacitance	f=100kHz, V <sub>CE</sub> =25 V, V <sub>GE</sub> =0 V	C <sub>ies</sub>	T <sub>vj</sub> =25°C	4472			pF
输出电容 Output capacitance				280			pF
反向传输电容 Reverse transfer capacitance				20			pF
门极电荷 Gate charge	I <sub>C</sub> = 75 A, V <sub>GE</sub> = 15 V, V <sub>CE</sub> = 520 V	Q <sub>G</sub>	T <sub>vj</sub> =25°C	273			nC
集电极-发射极截止电流 Collector-emitter cut-off current	V <sub>CE</sub> =650V , V <sub>GE</sub> = 0 V	I <sub>CES</sub>	T <sub>vj</sub> =25°C			1	mA
栅极-发射极漏电流 Gate-emitter leakage current	V <sub>CE</sub> =0 V, V <sub>GE</sub> = 20 V	I <sub>GES</sub>	T <sub>vj</sub> =25°C			200	nA
开通延迟时间 Turn-on delay time	I <sub>C</sub> =75A, V <sub>CE</sub> =300V V <sub>GE</sub> =±15 V, R <sub>G</sub> =8Ω (电感负载) / (inductive load)	t <sub>don</sub>	T <sub>vj</sub> =25°C T <sub>vj</sub> =175°C	38 34			ns
上升时间 Rise time	I <sub>C</sub> =75A, V <sub>CE</sub> =300V V <sub>GE</sub> =±15 V, R <sub>G</sub> =8Ω (电感负载) / (inductive load)	t <sub>r</sub>	T <sub>vj</sub> =25°C T <sub>vj</sub> =175°C	122 123			ns

## Typical Characteristics

关断延迟时间 Turn-off delay time	$I_C=75A, V_{CE}=300V$ $V_{GE}=\pm 15V, R_G=8\Omega$ (电感负载) / (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=175^\circ C$	$t_{doff}$		99 121		ns
下降时间 Fall time	$I_C=75A, V_{CE}=300V$ $V_{GE}=\pm 15V, R_G=8\Omega$ (电感负载) / (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=175^\circ C$	$t_f$		63 112		ns
开通损耗能量 (每脉冲) Turn-on energy loss per pulse	$I_C=75A, V_{CE}=300V$ $V_{GE}=\pm 15V, R_G=8\Omega$ $di/dt=500A/\mu s(T_{vj}=175^\circ C)$ (电感负载) / (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=175^\circ C$	$E_{on}$		2.49 4.70		mJ
关断损耗能量 (每脉冲) Turn-off energy loss per pulse	$I_C=75A, V_{CE}=300V$ $V_{GE}=\pm 15V, R_G=8\Omega$ $dv/dt=7300V/\mu s(T_{vj}=175^\circ C)$ (电感负载) / (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=175^\circ C$	$E_{off}$		1.00 1.52		mJ

## 二极管/Diode

### 最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
反向重复峰值电压 Repetitive peak reverse voltage	$T_{vj}=25^\circ C$	$V_{RRM}$	650	V
连续正向直流电流 Continuous DC forward current	$T_C=100^\circ C, T_{vj \max}=175^\circ C$	$I_F$	75	A
正向重复峰值电流 Repetitive peak forward current	$t_p=1ms$	$I_{FRM}$	300	A

### 特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
正向电压 Forward voltage	$I_F=75A, V_{GE}=0V$	$V_F$		1.38	1.8	V
	$I_F=75A, V_{GE}=0V$			1.18		
	$I_F=75A, V_{GE}=0V$			1.14		
反向恢复峰值电流 Peak reverse recovery current	$I_F=75A,$ $-di_F/dt=500A/\mu s(T_{vj}=175^\circ C)$ $V_R=300V, V_{GE}=-15V$	$I_{RM}$		18		A
				43		
反向恢复电荷 Reverse Recovered charge	$I_F=75A,$ $-di_F/dt=500A/\mu s(T_{vj}=175^\circ C)$ $V_R=300V, V_{GE}=-15V$	$Q_{rr}$		1.37		$\mu C$
				7.20		
反向恢复时间 Reverse Recovery Time	$I_F=75A,$ $-di_F/dt=500A/\mu s(T_{vj}=175^\circ C)$ $V_R=300V, V_{GE}=-15V$	$t_{rr}$		136		ns
				248		
反向恢复损耗 (每脉冲) Reverse recovered energy	$I_F=75A,$ $-di_F/dt=500A/\mu s(T_{vj}=175^\circ C)$ $V_R=300V, V_{GE}=-15V$	$E_{rec}$		0.20		mJ
				0.92		

## Typical Characteristics

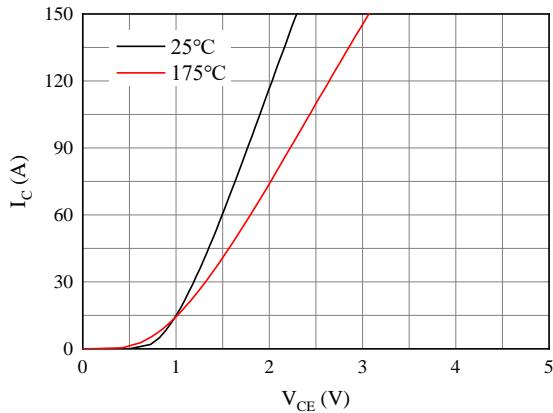


图 1. 典型输出特性 ( $V_{GE}=15V$ )

Figure 1. Typical output characteristics ( $V_{GE}=15V$ )

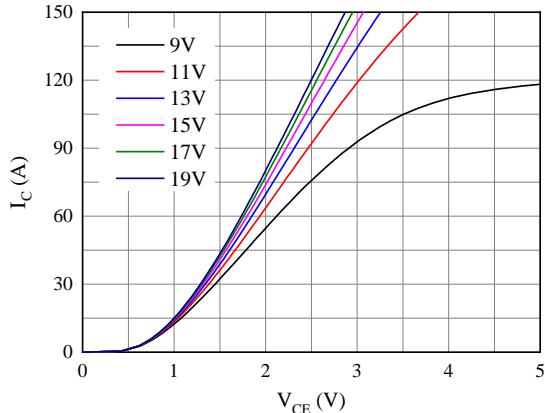


图 2. 典型输出特性 ( $T_{vj}=175^{\circ}C$ )

Figure 2. Typical output characteristics ( $T_{vj}=175^{\circ}C$ )

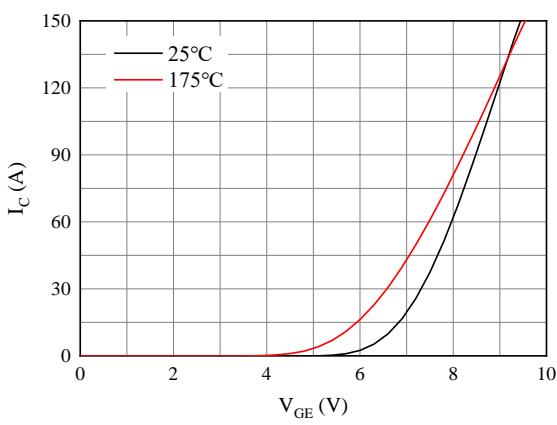


图 3. 典型传输特性( $V_{CE}=20V$ )

Figure 3. Typical transfer characteristic( $V_{CE}=20V$ )

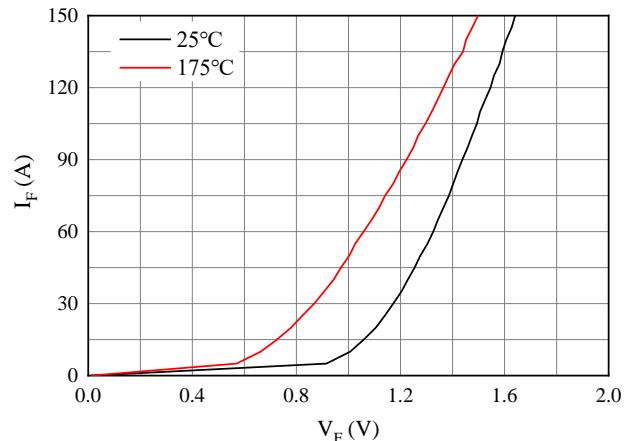


图 4. 正向偏压特性 二极管

Figure 4. Forward characteristic of Diode

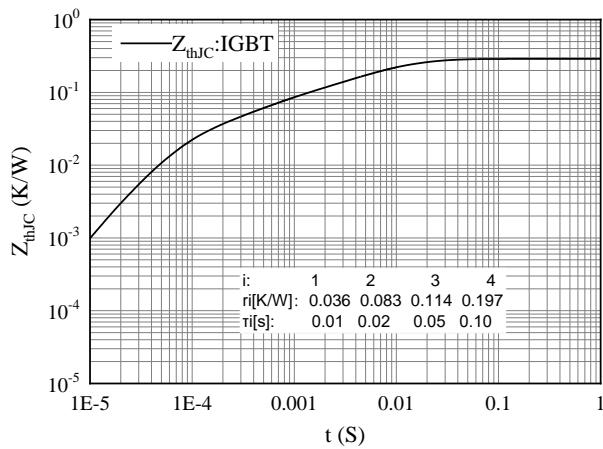


图 5. 瞬态热阻抗 IGBT

Figure 5. Transient thermal impedance IGBT,  
 $Z_{thJC}=f(t)$

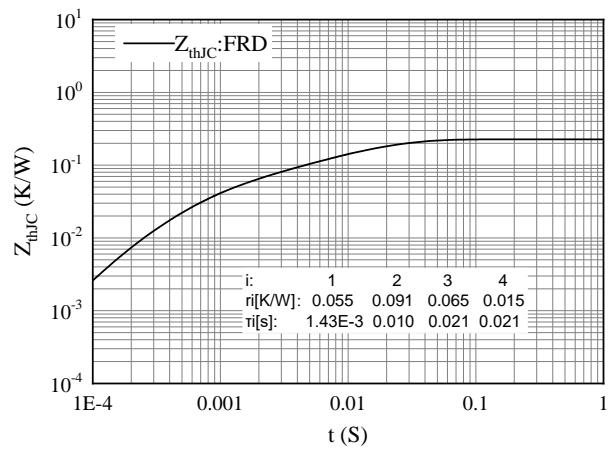


图 6. 瞬态热阻抗 FRD

Figure 6. Transient thermal impedance FRD,  
 $Z_{thJC}=f(t)$

## Typical Characteristics

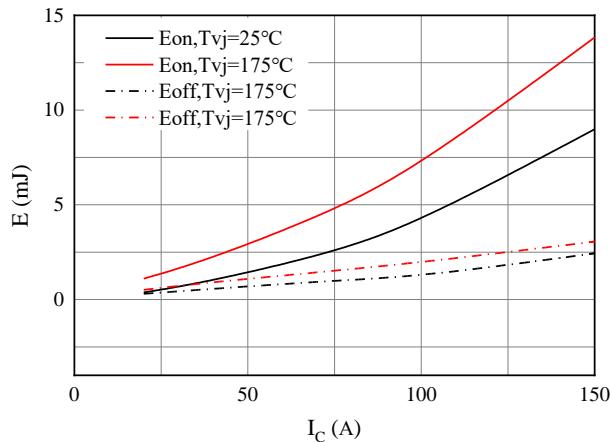


图 7. 开关损耗

Figure 7. Switching losses of IGBT  
 $V_{GE} = \pm 15V$ ,  $R_{gon} = 8\Omega$ ,  $R_{goff} = 8\Omega$ ,  $V_{CE} = 300V$

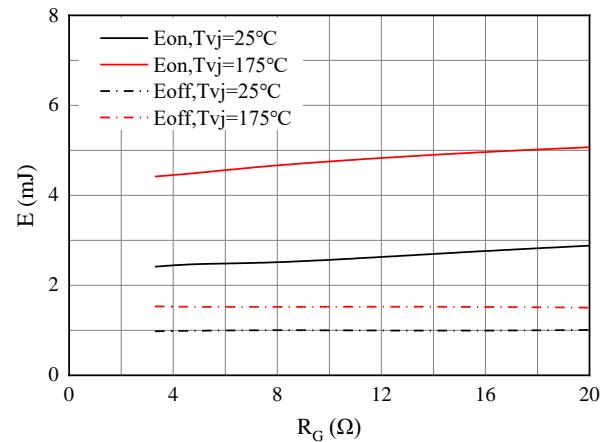


图 8. 开关损耗

Figure 8. Switching losses of IGBT  
 $V_{GE} = \pm 15V$ ,  $I_C = 75A$ ,  $V_{CE} = 300V$

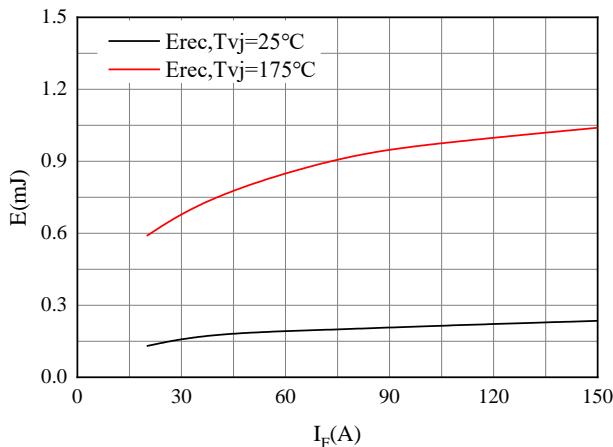


图 9. 开关损耗二极管

Figure 9. Switching losses of Diode  
 $R_{gon} = 8\Omega$ ,  $V_{CE} = 300V$

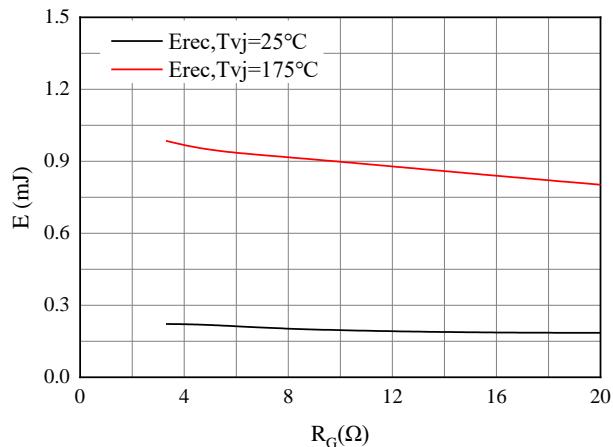


图 10. 开关损耗二极管

Figure 10. Switching losses of Diode  
 $I_F = 75A$ ,  $V_{CE} = 300V$

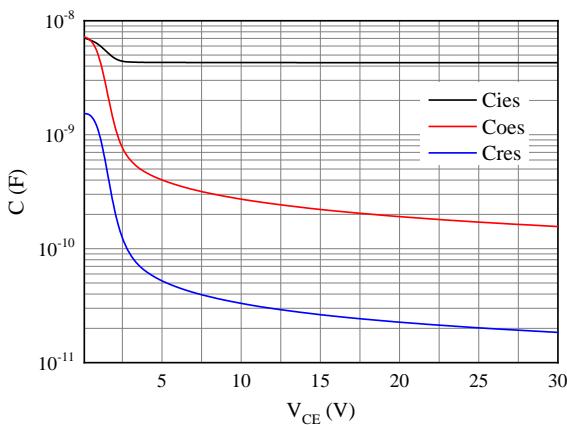
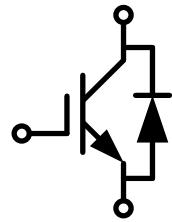


图 11. 电容特性

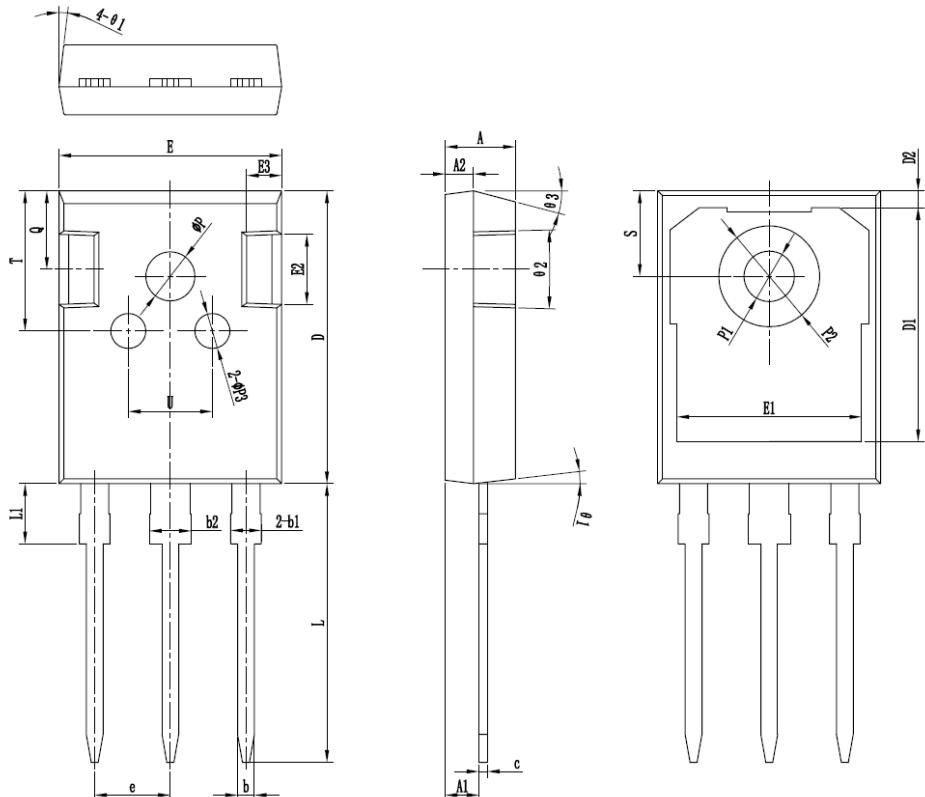
Figure 11. Capacitance characteristic

# Package Outline Dimensions

## 接线图 / Circuit diagram



## 封装尺寸 / Package outlines



符号	单位:mm		
	MIN	NOM	MAX
A	4.90	5.00	5.10
A <sub>1</sub>	2.31	2.41	2.51
A <sub>2</sub>	1.90	2.00	2.10
b	1.15	1.20	1.25
b <sub>1</sub>	1.95	2.10	2.25
b <sub>2</sub>	2.95	3.10	3.25
c	0.55	0.60	0.65
d	20.90	21.00	21.10
D <sub>1</sub>	16.35	16.55	16.75
D <sub>2</sub>	1.05	1.20	1.35
e	15.70	15.80	15.90
E <sub>1</sub>	13.10	13.25	13.40
E <sub>2</sub>	4.90	5.00	5.10
E <sub>3</sub>	2.40	2.50	2.60
e <sub>2</sub>	5.40	5.44	5.48
e <sub>3</sub>	19.80	19.92	20.10
e <sub>4</sub>	-	-	4.30
e <sub>5</sub> P	3.70	3.80	3.90
e <sub>6</sub> P <sub>1</sub>	3.50	3.60	3.70
e <sub>7</sub> P <sub>2</sub>	7.00	7.20	7.40
e <sub>8</sub> P <sub>3</sub>	2.40	2.50	2.60
Q	5.60	5.80	6.00
s <sub>5</sub>	6.05	6.15	6.25
J	9.80	10.00	10.20
U	6.00	6.20	6.40
θ <sub>1</sub>	5°	7°	9°
θ <sub>2</sub>	1°	3°	5°
θ <sub>3</sub>	13°	15°	17°

\*为关键管控尺寸